

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	EYRAN LIDA	10/05/2014
	AVIV SALAMON	10/05/2014
RECEIVING PARTY DATA		
Name:	Valens Semiconductor Ltd.	
Street Address:	8 Hanagar	
City:	Hod Hasharon	
State/Country:	ISRAEL	
Postal Code:	45240	
PROPERTY NUMBERS Total: 6		
Property Type	Number	
Application Number:	14482197	
Application Number:	14482245	
Application Number:	14482293	
Application Number:	14482340	
Application Number:	14482411	
Application Number:	14482484	
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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Correspondent Name:	ACTIVE KNOWLEDGE LTD.	
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NAME OF SUBMITTER:	TAL THIEBERGER	
SIGNATURE:	/Tal Thieberger/	
DATE SIGNED:	10/12/2014	
Total Attachments: 2		
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PATENT

ASSIGNMENT OF APPLICATION

WHEREAS, WE

Eyran Lida

Aviv Salamon

respectively, have invented certain new and useful improvements in:

Application Number	Filing Date	Title
14482197	Sep 10, 2014	Admission control while maintaining latency variations of existing sessions within their limits
14482245	Sep 10, 2014	Allocating limit to allowable end-to-end latency variation based on destination capability
14482293	Sep 10, 2014	Method and system for assigning vulnerability levels to sessions
14482340	Sep 10, 2014	Methods and systems for distributed calculations of latency variation
14482411	Sep 10, 2014	Methods and systems for incremental calculation of latency variation
14482484	Sep 10, 2014	Increasing link throughput to enable admission without exceeding latency variation limits

and

WHEREAS, Valens Semiconductor Ltd.

(hereinafter referred to as "ASSIGNEE"), 8 Hanagar, Hod Hasharon, 45240, ISRAEL, a limited liability company incorporated under the Laws of Israel, is desirous of acquiring the entire right, title and interest in and to said inventions and in and to any Letters Patents that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, for valuable consideration, receipt whereof is hereby acknowledged, and for other good and valuable consideration, WE, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said inventions in the United States and in all foreign countries and the entire right, title and interest in and to any and all Letters Patents which may be granted therefore in the United

States and in any and all foreign countries and in and to any and all divisions, reissues, continuations, CIPs, substitutions and renewals thereof.

WE, hereby authorize and request the Patent Office Officials in the United States and any and all foreign countries to issue any and all of said Letters Patents, when granted, to said ASSIGNEE as the assignee of our entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patents may be granted, as fully and entirely as the same would have been held by us had this Assignment and sale not been made.

Further, WE agree that WE will communicate to said ASSIGNEE or its representatives any facts known to us respecting said inventions, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, CIP, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patents to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said inventions in the United States and in any and all foreign countries.

The undersigned hereby grant the ASSIGNEE the power to insert on this assignment any further identifications, including application numbers and filing dates, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Oct 5, 2014	Eyran Lida	/Eyran Lida/
<u>Date</u>	<u>Name of Inventor</u>	<u>Signature of Inventor</u>

Oct 5, 2014	Aviv Salamon	/Aviv Salamon/
<u>Date</u>	<u>Name of Inventor</u>	<u>Signature of Inventor</u>